

# Supporting Information

## Reconfigurable Manipulation of Oxygen Content on Metal Oxide Surfaces and Applications to Gas Sensing

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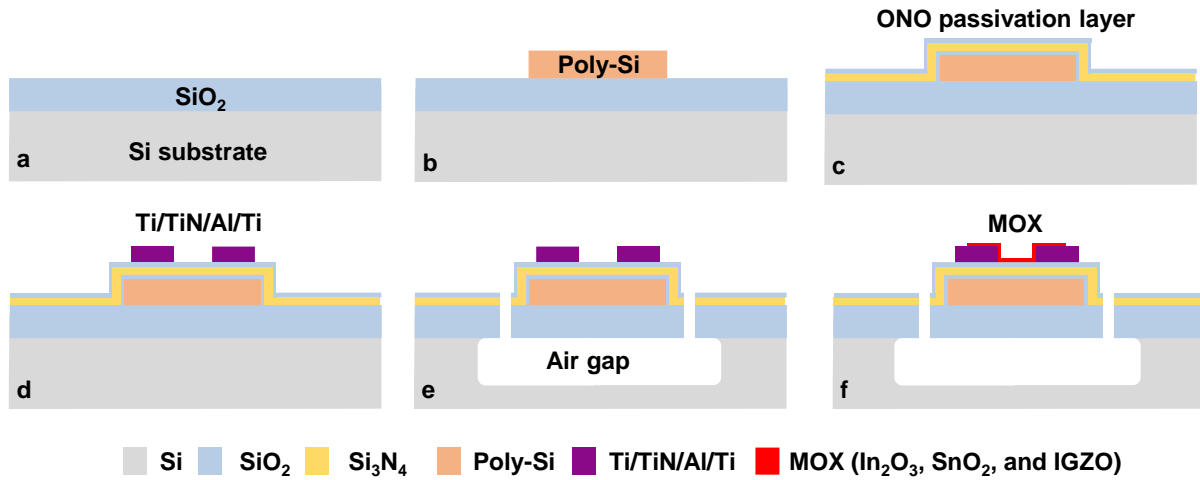


Figure S1. Fabrication processes of MOX devices. (a) 350 nm thick silicon oxide is thermally grown through wet oxidation. (b)  $n^+$ -doped polysilicon is deposited and patterned to form microheaters (gates). (c) Deposition of the passivation layer of  $\text{SiO}_2/\text{Si}_3\text{N}_4/\text{SiO}_2$  (10 nm/20 nm/10 nm) to prevent contamination. (d) Metal line (Ti/TiN/Al/TiN (20 nm/20 nm/70 nm/20 nm)) formation after defining the contact holes. (e) Formation of an air gap to prevent heat loss. (f) Deposition and patterning of the MOX layer ( $\text{In}_2\text{O}_3$ ,  $\text{SnO}_2$ , and IGZO).

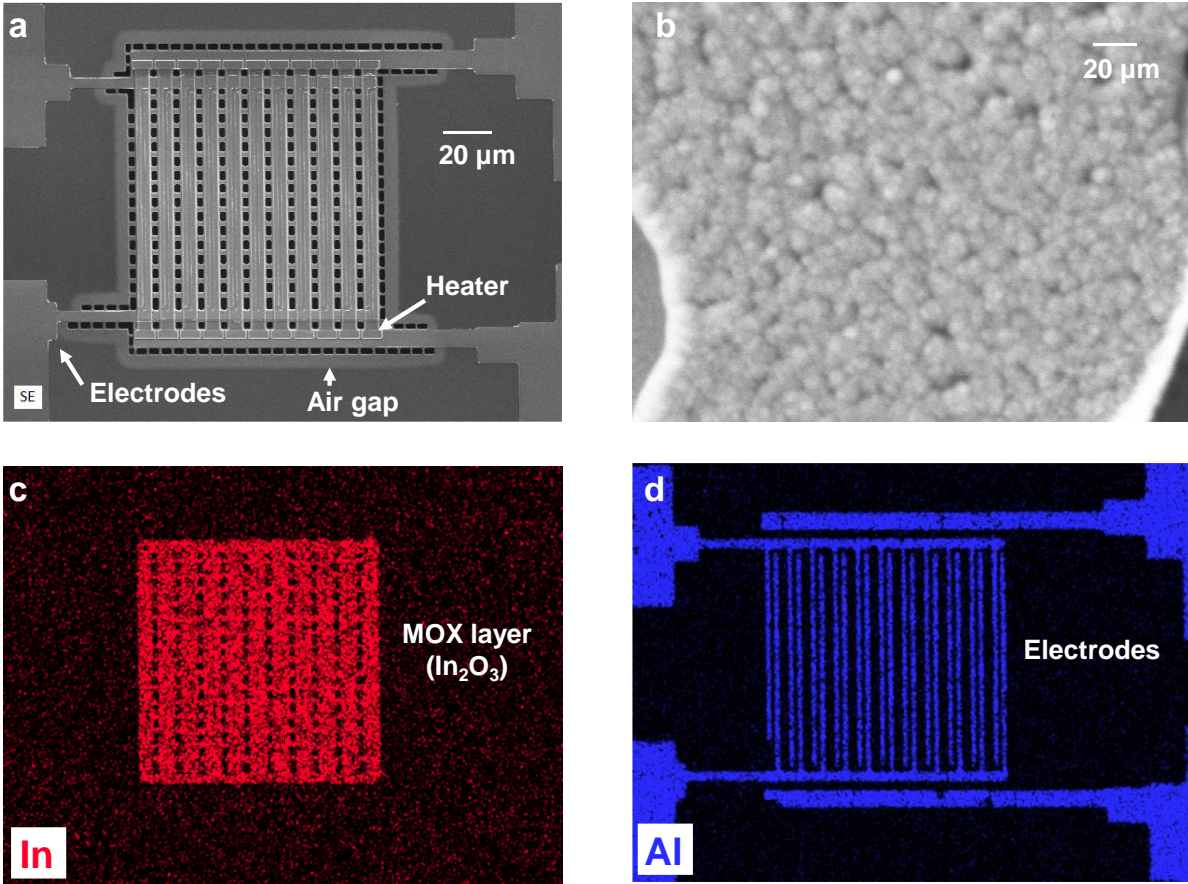


Figure S2. Scanning electron microscopy (SEM) images and energy-dispersive X-ray spectroscopy (EDS) mapping images of the fabricated device with In<sub>2</sub>O<sub>3</sub>. (a) Top SEM image of the fabricated resistive SMOX gas sensor with a microheater. (b) Top SEM image of In<sub>2</sub>O<sub>3</sub>. EDS mapping images of (c) indium and (d) aluminum.

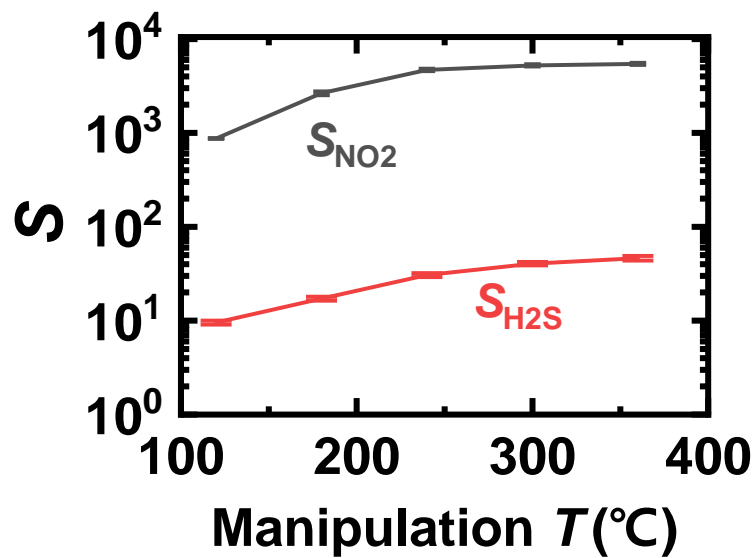


Figure S3. Response characteristics of an  $In_2O_3$  gas sensor to 500 ppb  $NO_2$  gas and 50 ppm  $H_2S$  gas as a function of oxygen manipulation temperature.

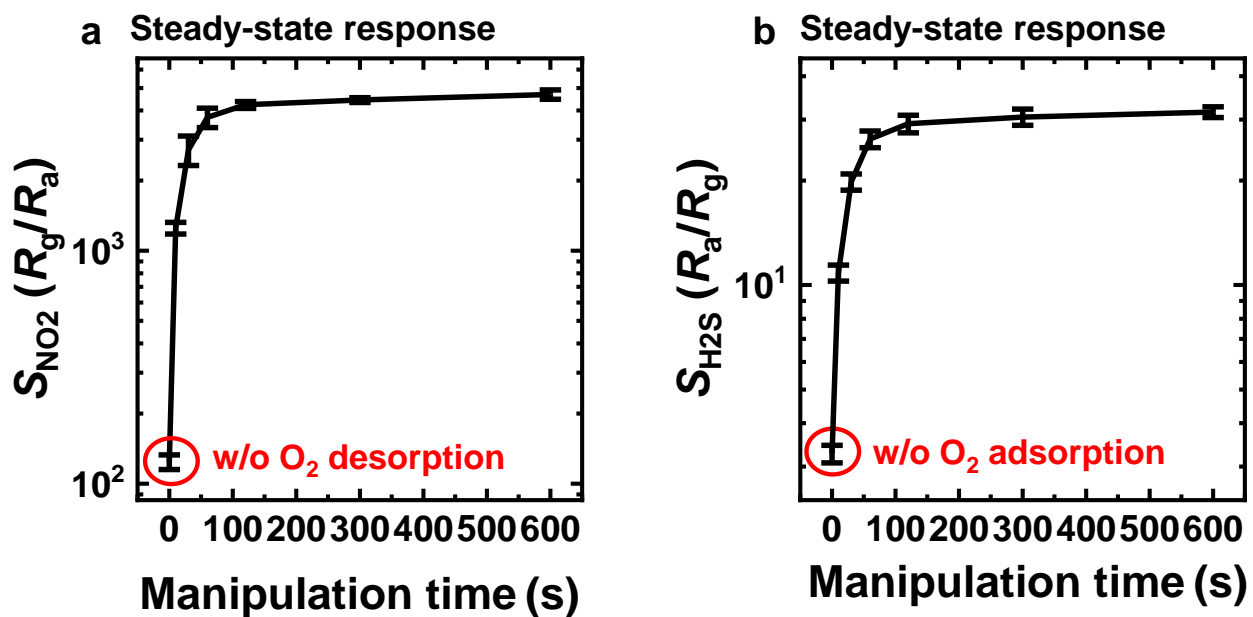


Figure S4. Response characteristics of an In<sub>2</sub>O<sub>3</sub> gas sensor to 500 ppb NO<sub>2</sub> gas (a) and 50 ppm H<sub>2</sub>S gas (b) as a function of oxygen manipulation time at 240 °C.

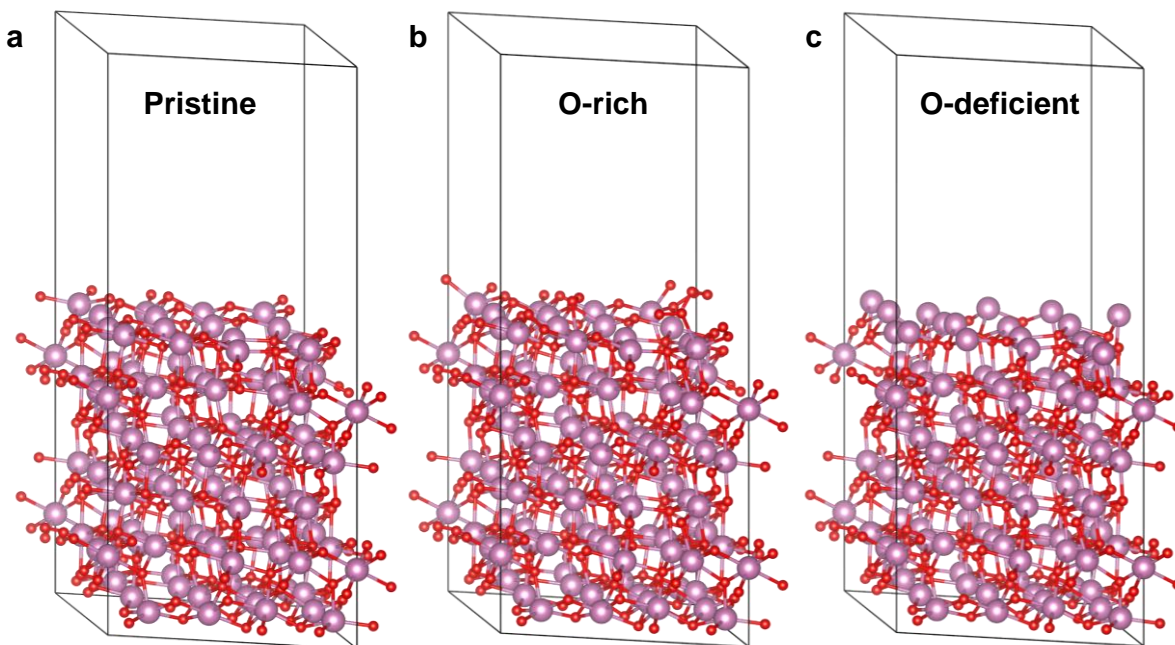


Figure S5. Various  $\text{In}_2\text{O}_3$  slabs used for DFT calculations. (a) Pristine, (b) O-rich, and (c) O-deficient indium oxide structures.

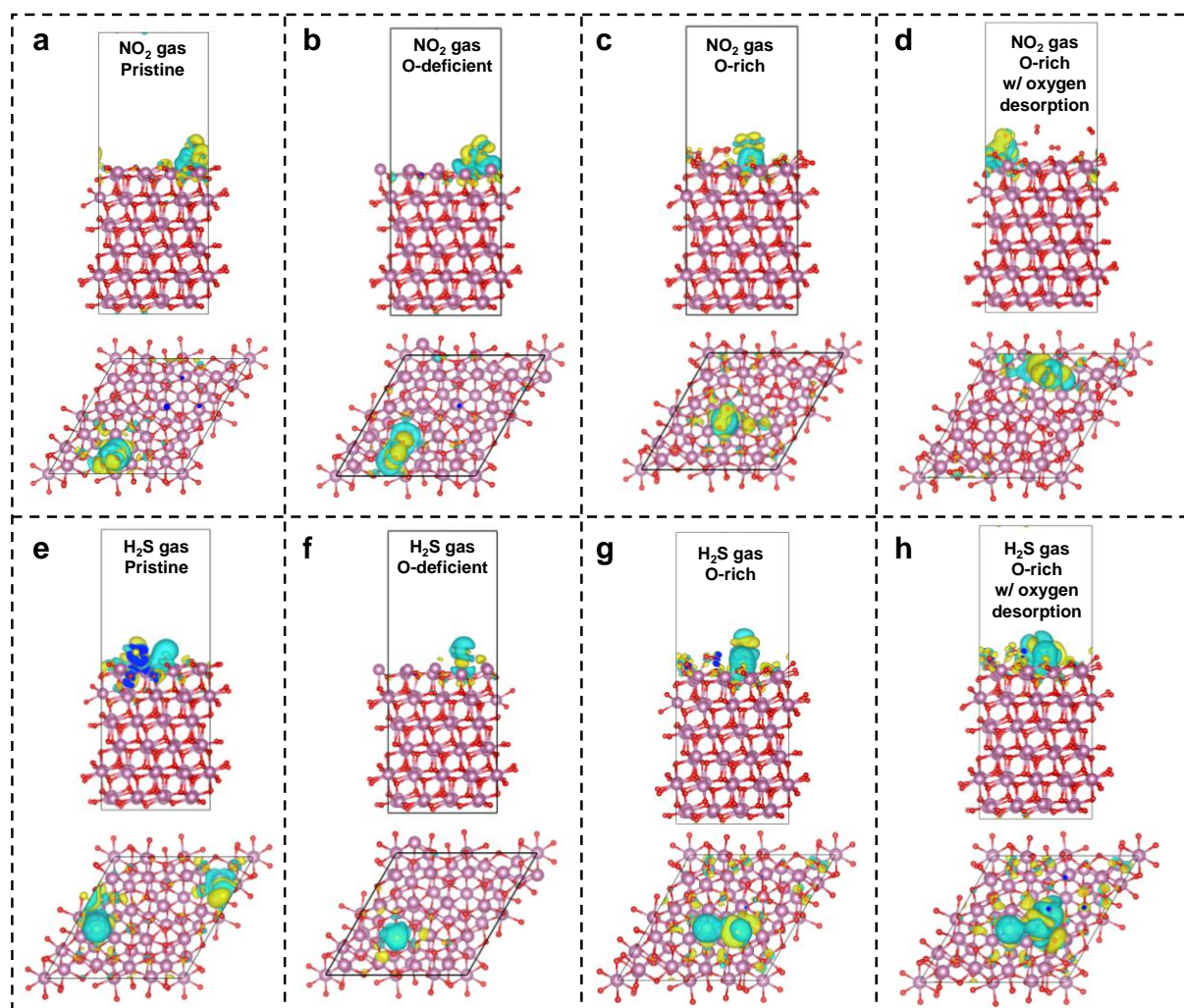


Figure S6. Bader charge analyses of  $\text{NO}_2$  and  $\text{H}_2\text{S}$  gas adsorption on the  $\text{In}_2\text{O}_3$  (111) surface. Bader charge difference plots of (a)–(d)  $\text{NO}_2$  gas and (e)–(h)  $\text{H}_2\text{S}$  gas adsorption on pristine (a, e), O-deficient (b, f), and O-rich (c, d, g, h)  $\text{In}_2\text{O}_3$  surfaces. The blue and yellow charge distributions represent the positive and negative electron density changes after gas adsorption, respectively.



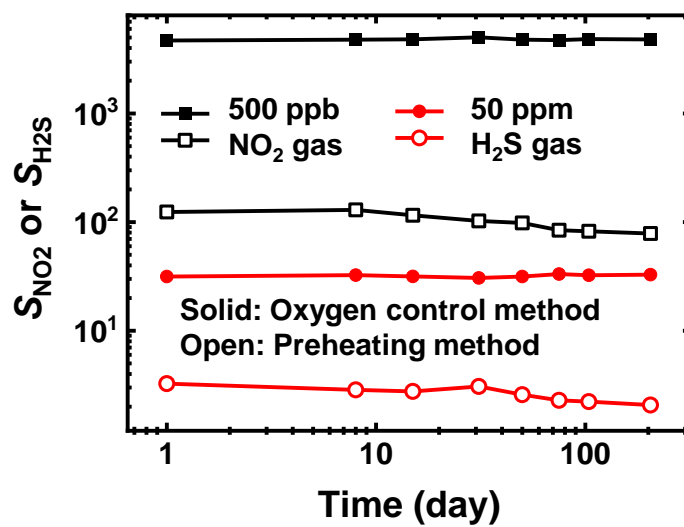


Figure S7. Steady-state response of the sensor to 500 ppb NO<sub>2</sub> and 50 ppm H<sub>2</sub>S gas over time using the conventional preheating method and the proposed oxygen control method.

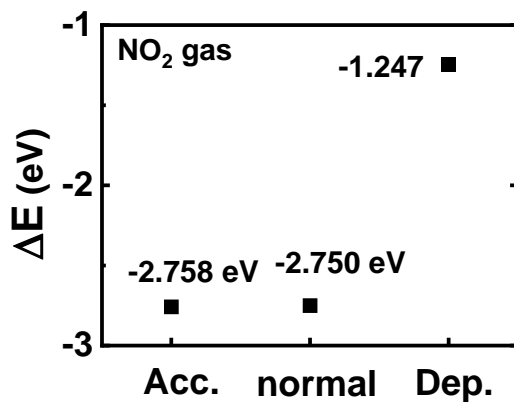


Figure S8. Binding energy ( $\Delta E$ ) values of  $\text{NO}_2$  at different  $\text{In}_2\text{O}_3$  electron concentrations.

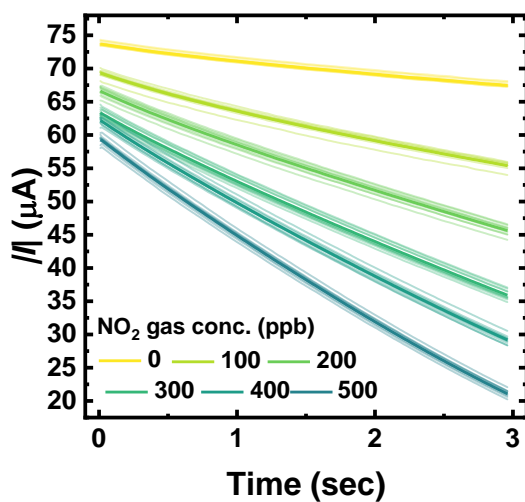


Figure S9. Transient responses of the sensors to 0–500 ppb  $\text{NO}_2$  gas obtained after using the gas desorption method. Ten transient responses from each of the six gas concentrations and their average values are shown as transparent and solid lines, respectively.

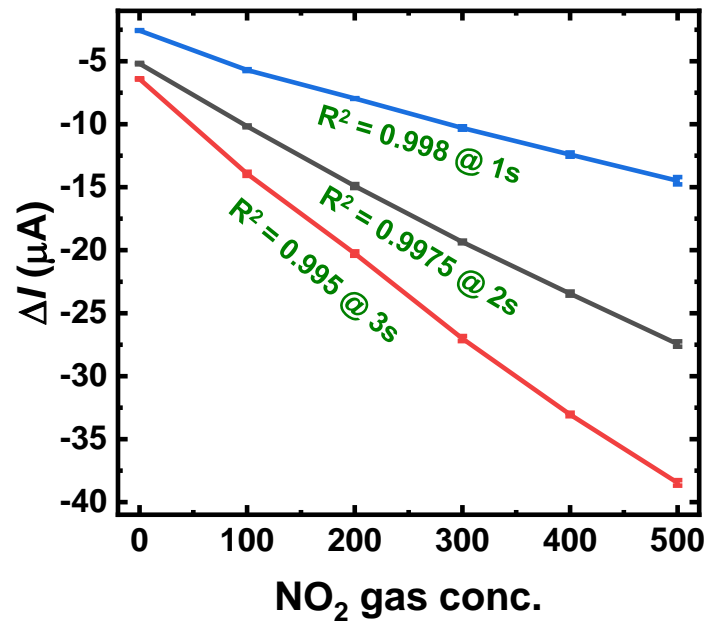


Figure S10.  $\Delta I$  versus NO<sub>2</sub> gas concentration. The mean and one standard deviation of 10  $\Delta I$  are plotted using error bars.

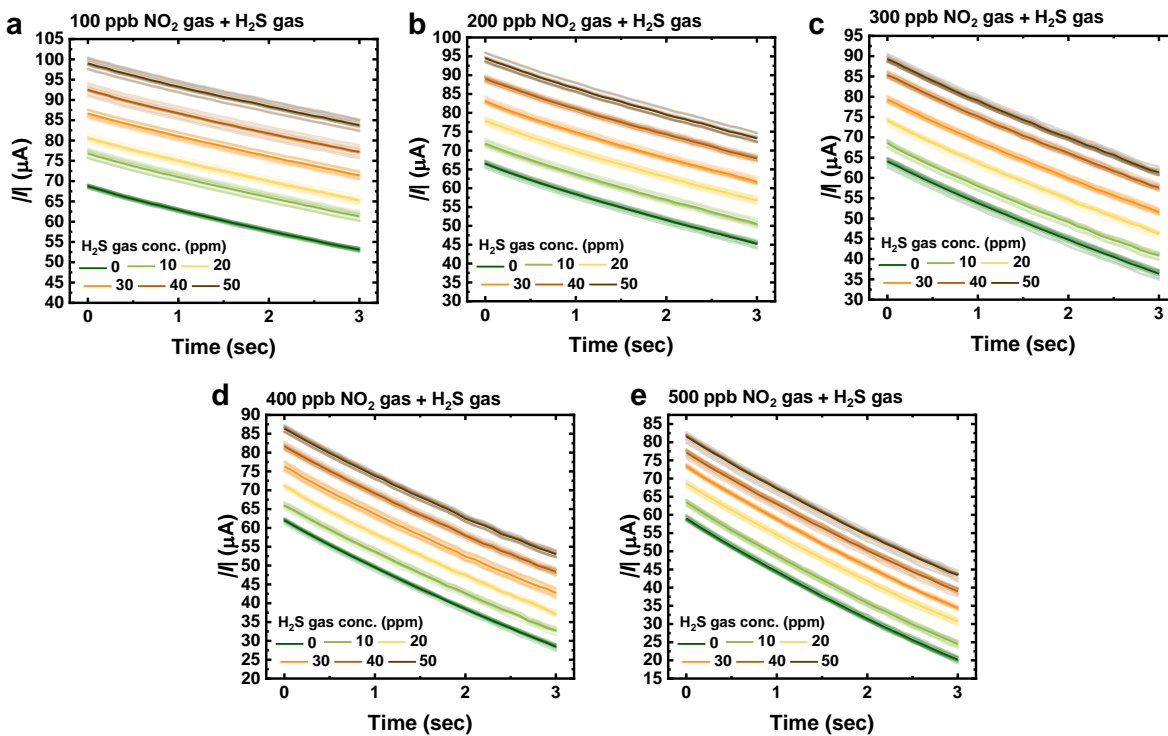


Figure S11. Transient sensor responses to NO<sub>2</sub> and H<sub>2</sub>S gas mixtures after oxygen desorption.

(a)-(e) The sensor is exposed to a combination of 100–500 ppb NO<sub>2</sub> gas and 10–50 ppm H<sub>2</sub>S gas.

Ten transient responses from each of the six gas concentrations and their average values are shown as transparent and solid lines, respectively.

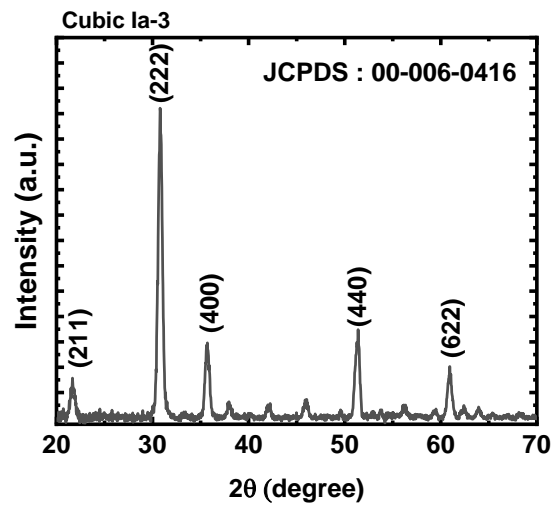


Figure S12. GIXRD pattern of 18 nm  $\text{In}_2\text{O}_3$  film.

Table S1. Area ratio of the bands fitted to the  $O_{1s}$  XPS peak from the indium oxide film.

	O-In (%)	Others (%)
Pristine	49.7	50.3
O-deficient	47.9	52.1
O-rich	53.8	46.2

Table S2. Area ratio of the bands fitted to the  $In_{3d}$  XPS peak.

	O-In (%)	Others (%)
Pristine	79.2	20.8
O-deficient	73.4	26.6
O-rich	81.8	18.2

Table S3. Bader charge analyses of  $NO_2$  gas adsorption on the  $In_2O_3$  (111) surface.

	Surface	N	O	O
Pristine	0.034	0.827	-0.500	-0.361
O-deficient	0.614	0.397	-0.580	-0.432
O-rich (w/ oxygen desorption)	0.157	0.862	-0.622	-0.396
O-rich (w/o oxygen desorption)	-0.110	0.854	-0.385	-0.359

Table S4. Bader charge analyses of  $H_2S$  gas adsorption on the  $In_2O_3$  (111) surface.

	Surface	S	H	H
Pristine	-0.172	-0.450	0.035	0.587
O-deficient	-0.054	-0.097	0.066	0.085
O-rich (w/ oxygen desorption)	-2.347	1.651	0.093	0.603
O-rich (w/o oxygen desorption)	-1.277	0.605	0.058	0.614